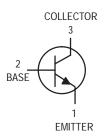
General Purpose Transistors

NPN Silicon



2N2219 2N2219A* 2N2222 2N2222A*

*Motorola Preferred Devices

MAXIMUM RATINGS

Rating	Symbol	2N2219 2N2222	2N2219A 2N2222A	Unit
Collector-Emitter Voltage	V _{CEO}	30	40	Vdc
Collector-Base Voltage	V _{CBO}	60	75	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	6.0	Vdc
Collector Current — Continuous	I _C	800	800	mAdc
		2N2219,A	2N2222,A	
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	0.8 4.57	0.4 2.28	Watts mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	3.0 17.1	1.2 6.85	Watts mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	2N2219,A	2N2222,A	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	219	437.5	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	58	145.8	°C/W



2N2219,A CASE 79-04, STYLE 1 TO-39 (TO-205AD)



2N2222,A CASE 22-03, STYLE 1 TO-18 (TO-206AA)

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteris	tic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				•	•
Collector-Emitter Breakdown Voltage (I _C = 10 mAdc, I _B = 0)	Non–A Suffix A–Suffix	V _{(BR)CEO}	30 40	_ _	Vdc
Collector–Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	Non–A Suffix A–Suffix	V _{(BR)CBO}	60 75	_	Vdc
Emitter–Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$)	Non–A Suffix A–Suffix	V _{(BR)EBO}	5.0 6.0	_	Vdc
Collector Cutoff Current (V _{CE} = 60 Vdc, V _{EB(off)} = 3.0 Vdc)	A–Suffix	I _{CEX}	_	10	nAdc
	Non-A Suffix A-Suffix Non-A Suffix A-Suffix	Ісво	_ _ _ _	0.01 0.01 10 10	μAdc
Emitter Cutoff Current (V _{EB} = 3.0 Vdc, I _C = 0)	A–Suffix	I _{EBO}	_	10	nAdc
Base Cutoff Current (V _{CE} = 60 Vdc, V _{EB(off)} = 3.0 Vdc)	A–Suffix	I _{BL}	_	20	nAdc

Preferred devices are Motorola recommended choices for future use and best overall value.

(Replaces 2N2218A/D)



2N2219 2N2219A 2N2222 2N2222A

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic		Symbol	Min	Max	Unit
ON CHARACTERISTICS				-	•
DC Current Gain $ \begin{aligned} &(I_C=0.1 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \\ &(I_C=1.0 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \\ &(I_C=10 \text{ mAdc, } V_{CE}=10 \text{ Vdc})^{(1)} \\ &(I_C=10 \text{ mAdc, } V_{CE}=10 \text{ Vdc, } T_A=-55^{\circ}\text{C})^{(1)} \\ &(I_C=150 \text{ mAdc, } V_{CE}=10 \text{ Vdc})^{(1)} \\ &(I_C=150 \text{ mAdc, } V_{CE}=10 \text{ Vdc})^{(1)} \\ &(I_C=500 \text{ mAdc, } V_{CE}=10 \text{ Vdc})^{(1)} \end{aligned} $	2N2219,A, 2N2222,A 2N2219,A, 2N2222,A 2N2219,A, 2N2222,A 2N2219,A, 2N2222,A 2N2219,A, 2N2222,A 2N2219,A, 2N2222,A 2N2219, 2N2222,A 2N2219, 2N2222	h _{FE}	35 50 75 35 100 50 30 40		_
Collector-Emitter Saturation Voltage ⁽¹⁾ (I _C = 150 mAdc, I _B = 15 mAdc)	Non–A Suffix A–Suffix	V _{CE(sat)}	_ _	0.4 0.3	Vdc
$(I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc})$	Non–A Suffix A–Suffix		_ _	1.6 1.0	
Base-Emitter Saturation Voltage ⁽¹⁾ (I _C = 150 mAdc, I _B = 15 mAdc)	Non–A Suffix A–Suffix	V _{BE(sat)}	0.6 0.6	1.3 1.2	Vdc
$(I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc})$	Non-A Suffix A-Suffix		_ _	2.6 2.0	
SMALL-SIGNAL CHARACTERISTICS		•			•
Current-Gain — Bandwidth Product ⁽²⁾ ($I_C = 20 \text{ mAdc}, V_{CE} = 20 \text{ Vdc}, f = 100 \text{ MHz}$)	All Types, Except 2N2219A, 2N2222A	fT	250 300	_	MHz
Output Capacitance ⁽³⁾ ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f = 1.0 \text{ MHz}$)		C _{obo}	_	8.0	pF
Input Capacitance ⁽³⁾ ($V_{EB} = 0.5 \text{ Vdc}, I_{C} = 0, f = 1.0 \text{ MHz}$)	Non–A Suffix A–Suffix	C _{ibo}	_ _	30 25	pF
Input Impedance (I _C = 1.0 mAdc, V_{CE} = 10 Vdc, f = 1.0 kHz) (I _C = 10 mAdc, V_{CE} = 10 Vdc, f = 1.0 kHz)	2N2219A, 2N2222A 2N2219A, 2N2222A	h _{je}	2.0 0.25	8.0 1.25	kΩ
Voltage Feedback Ratio ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$) ($I_C = 10 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)	2N2219A, 2N2222A 2N2219A, 2N2222A	h _{re}	_ _	8.0 4.0	X 10 ⁻⁴
Small–Signal Current Gain ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$) ($I_C = 10 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)	2N2219A, 2N2222A 2N2219A, 2N2222A	h _{fe}	50 75	300 375	_
Output Admittance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$) ($I_C = 10 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)	2N2219A, 2N2222A 2N2219A, 2N2222A	h _{oe}	5.0 15	35 200	μmhos
Collector Base Time Constant (I _E = 20 mAdc, V _{CB} = 20 Vdc, f = 31.8 MHz)	A–Suffix	rb′C _c	_	150	ps
Noise Figure (I _C = 100 μ Adc, V _{CE} = 10 Vdc, R _S = 1.0 k Ω , f = 1.0 kHz)	2N2222A	NF	_	4.0	dB
Real Part of Common–Emitter High Frequency Input Impedance (I _C = 20 mAdc, V _{CE} = 20 Vdc, f = 300 MHz)	2N2219A, 2N2222A	Re(h _{je})	_	60	Ω

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

^{2.} f_T is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.
3. 2N5581 and 2N5582 are listed C_{cb} and C_{eb} for these conditions and values.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

	Symbol	Min	Max	Unit			
SWITCHING CHA	SWITCHING CHARACTERISTICS						
Delay Time	$(V_{CC} = 30 \text{ Vdc}, V_{BE(off)} = -0.5 \text{ Vdc},$ $I_{C} = 150 \text{ mAdc}, I_{B1} = 15 \text{ mAdc})$	t _d	_	10	ns		
Rise Time	(Figure 12)	t _r		25	ns		
Storage Time	(V _{CC} = 30 Vdc, I _C = 150 mAdc, I _{B1} = I _{B2} = 15 mAdc)	t _s	-	225	ns		
Fall Time	(Figure 13)	t _f	1	60	ns		
Active Region Time Constant ($I_C = 150 \text{ mAdc}$, $V_{CE} = 30 \text{ Vdc}$) (See Figure 11 for 2N2219A, 2N2222A)		T _A	_	2.5	ns		

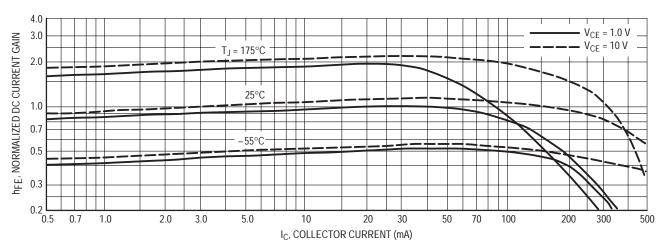
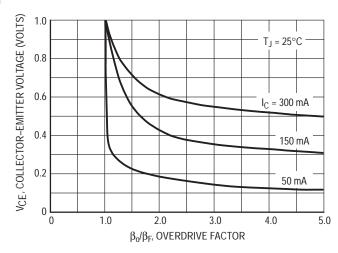


Figure 1. Normalized DC Current Gain



This graph shows the effect of base current on collector current. β_0 (current gain at the edge of saturation) is the current gain of the transistor at 1 volt, and β_F (forced gain) is the ratio of I_C/I_{BF} in a circuit.

EXAMPLE: For type 2N2219, estimate a base current (I_{BF}) to insure saturation at a temperature of 25°C and a collector current of 150 mA.

Observe that at I_C = 150 mA an overdrive factor of at least 2.5 is required to drive the transistor well into the saturation region. From Figure 1, it is seen that h_{FE} @ 1 volt is approximately 0.62 of h_{FE} @ 1 volts. Using the guaranteed minimum gain of 100 @ 150 mA and 10 V, β_0 = 62 and substituting values in the overdrive equation, we find:

$$\frac{\beta_{0}}{\beta_{F}} = \frac{h_{FE} @ 1.0 \text{ V}}{I_{C}/I_{BF}}$$
 $2.5 = \frac{62}{150/I_{BF}}$ $I_{BF} \approx 6.0 \text{ mA}$

Figure 2. Collector Characteristics in Saturation Region

2N2219 2N2219A 2N2222 2N2222A

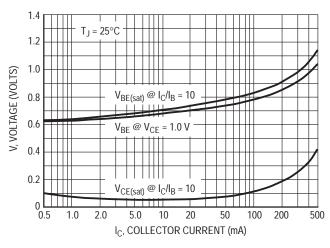


Figure 3. "On" Voltages

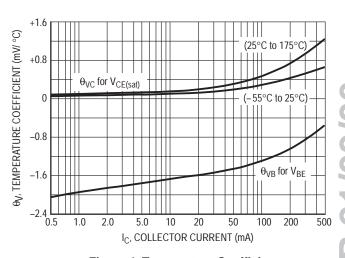


Figure 4. Temperature Coefficients

h PARAMETERS

 $V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C}$

This group of graphs illustrates the relationship between h_{fe} and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were selected and the same units were used to develop the correspondingly numbered curves on each graph.



Figure 5. Input Impedance

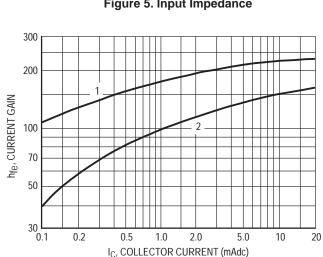


Figure 7. Current Gain

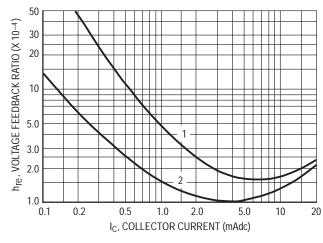


Figure 6. Voltage Feedback Ratio

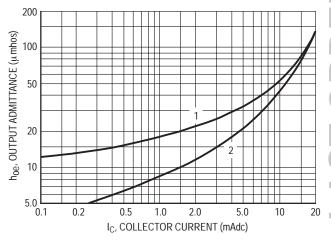


Figure 8. Output Admittance

SWITCHING TIME CHARACTERISTICS

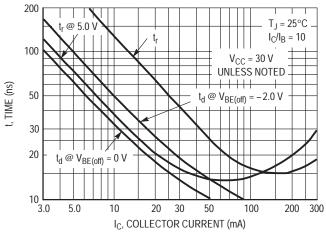


Figure 9. Turn-On Time

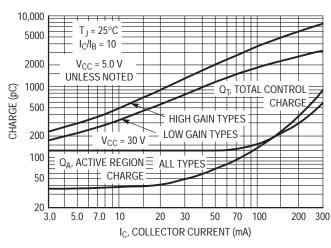
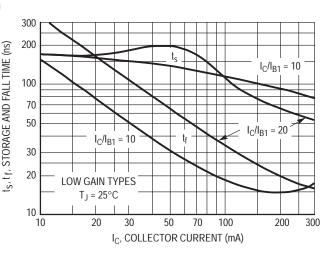


Figure 10. Charge Data



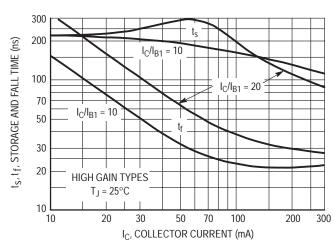


Figure 11. Turn-Off Behavior

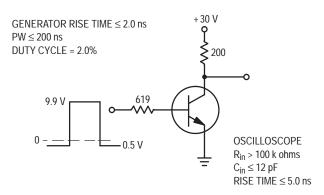


Figure 12. Delay and Rise Time Equivalent Test Circuit

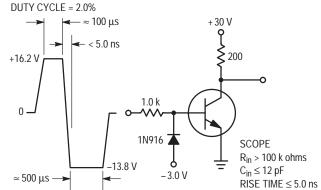
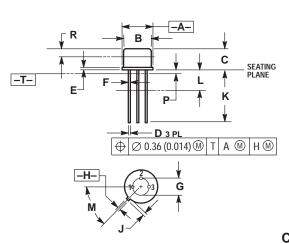


Figure 13. Storage Time and Fall Time Equivalent Test Circuit

PACKAGE DIMENSIONS



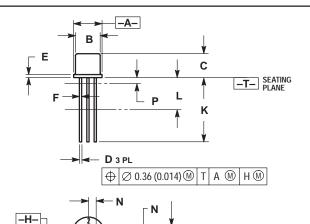
NOTES

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- CONTROLLING DIMENSION: INCH
- 3. DIMENSION J MEASURED FROM DIMENSION A
- 4. DIMENSION B SHALL NOT VARY MORE THAN 0.25 (0.010) IN ZONE R. THIS ZONE
- CONTROLLED FOR AUTOMATIC HANDLING.
 5. DIMENSION F APPLIES BETWEEN DIMENSION P AND L. DIMENSION D APPLIES BETWEEN DIMENSION L AND K MINIMUM. LEAD DIAMETER IS UNCONTROLLED IN DIMENSION P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.335	0.370	8.51	9.39
В	0.305	0.335	7.75	8.50
С	0.240	0.260	6.10	6.60
D	0.016	0.021	0.41	0.53
Ε	0.009	0.041	0.23	1.04
F	0.016	0.019	0.41	0.48
G	0.200	BSC	5.08 BSC	
Н	0.028	0.034	0.72	0.86
J	0.029	0.045	0.74	1.14
K	0.500	0.750	12.70	19.05
L	0.250		6.35	
M	45 °BSC		45°	BSC
Р		0.050		1.27
R	0.100		2.54	

STYLE 1: PIN 1. EMITTER BASE COLLECTOR

CASE 079-04 (TO-205AD) ISSUE N



G

NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982
- CONTROLLING DIMENSION: INCH
- DIMENSION J MEASURED FROM DIMENSION A MAXIMUM.
- DIMENSION F APPLIES BETWEEN DIMENSION P AND L. DIMENSION D APPLIES BETWEEN DIMENSION L AND K MINIMUM. LEAD DIAMETER IS UNCONTROLLED IN DIMENSION P AND
- BEYOND DIMENSION K MINIMUM.

 5. DIMENSION E INCLUDES THE TAB THICKNESS. (TAB THICKNESS IS 0.51(0.002) MAXIMUM).

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.209	0.230	5.31	5.84	
В	0.178	0.195	4.52	4.95	
С	0.170	0.210	4.32	5.33	
D	0.016	0.021	0.406	0.533	
Ε		0.030		0.762	
F	0.016	0.019	0.406	0.483	
G	0.100	BSC	2.54 BSC		
Н	0.036	0.046	0.914	1.17	
J	0.028	0.048	0.711	1.22	
K	0.500		12.70		
L	0.250		6.35		
M	45 °BSC		45 °BSC		
N	0.050 BSC		1.27 BSC		
P		0.050		1.27	

STYLE 1: PIN 1. EMITTER 3. COLLECTOR



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